

IN THE CLAIMS

Please amend the claims as follows:

Claim 1 (Currently Amended): A multilayer wired board ~~constituting~~ including at least part of ~~[[a]]~~ an electrical circuit board in which a plurality of wired boards are stacked so as to face their wired surfaces toward each other, ~~wherein~~ comprising:

electrical connection parts between said multilayer wired boards are connected through an elastic conductive material part adhered to one of said wired boards; and

a double-sided adhesive material part is provided between the plurality of wired boards to adhere them together, and an opening is formed in the double-sided adhesive material part so as to surround at least part of a peripheral edge portion of said elastic conductive material part ~~is adhered by a double-sided adhesive material part~~ to seal said plurality of multilayer wired boards.

Claim 2 (Original): The multilayer wired board according to claim 1, wherein said elastic conductive material part is formed in a convex shape, the bottom of said elastic conductive material part is adhered to one of said wired boards and the top of said elastic conductive material part is adhered to an electrical connection part of other side of said wired board, whereby electrical connection is established.

Claim 3 (Currently Amended): The multilayer wired board according to claim 1, wherein said elastic conductive material part is formed in a convex shape and the height from the bottom to the top of said elastic conductive ~~board~~ material part is set to 200-400 μm .

Claim 4 (Original): A method of a multilayer wired board constituting at least part of a electrical circuit board in which a plurality of wired boards are stacked so as to face their wired surfaces each other, comprising the steps of:

adhering an elastic conductive material part to an electric connection part of one of said wired boards;

forming an opening in a double-sided adhesive material part so as to surround at least part of the peripheral edge of said elastic conductive material part;

adhering said double-sided adhesive material part to a wired board adhered said elastic conductive material part or other wired board whose wired surface to be faced to said wired surface; and

adhering said both wired boards together by said double-sided adhesive material part under the state in which the top of said elastic conductive material part is contacted to the electrical connection part of said other wired board whose wired surface to be faced to said wired surface.

Claim 5 (Original): The method of a multilayer wired board according to claim 4, wherein said elastic conductive material part is formed in a convex shape.

Claim 6 (Original): The method of a multilayer wired board according to claim 4, wherein said elastic conductive material part is formed in a convex shape and the height from the bottom to the top of said elastic conductive board is set to 200-400 μm .

Claim 7 (Currently Amended): A touch panel comprising ~~the configuration such that~~ a light transmission first board having a light transmission conductive layer formed as a predetermined pattern thereon and a light transmission second board made of a flexible

material having a light transmission conductive layer thereon ~~is placed opposite to~~ and
opposing said first board ~~[[with]]~~ by a predetermined distance, ~~wherein:~~

electrical connection parts between said first board and said second board ~~[[are]]~~
being connected through an elastic conductive material part adhered only to said first board,
a double-sided adhesive material part provided between the plurality of wired boards
to adhere them together, and an opening being formed in the double-sided adhesive material
part so as to surround at least part of a peripheral edge portion of said elastic conductive
material part ~~is adhered by a double-sided adhesive material part~~ to seal said first board and
said second board.

Claim 8 (Original): The touch panel according to claim 7, wherein said elastic
conductive material part is formed in a convex shape, the bottom of said elastic conductive
material part is adhered to said first board and the top of said elastic conductive material part
is adhered to an electrical connection part of said second board, whereby electrical
connection is established.

Claim 9 (Currently Amended): The touch panel according to claim 7, wherein said
elastic conductive material part is formed in a convex shape and the height from the bottom
to the top of said elastic conductive ~~board~~ material part is set to 200-400 μm .

Claim 10 (Original): A method of a touch panel comprising the configuration such
that a light transmission first board having a light transmission conductive layer formed as a
predetermined pattern thereon and a light transmission second board made of a flexible
material having a light transmission conductive layer thereon is placed opposite to said first
board with a predetermined distance, comprising the steps of:

adhering an elastic conductive material part to an electric connection part of said first board;

forming an opening in a double-sided adhesive material part so as to surround at least part of the peripheral edge of said elastic conductive material part;

adhering said double-sided adhesive material part to said first board and said second; and

adhering said both first and second board together by said double-sided adhesive material part under the state in which the top of said elastic conductive material part is contacted to the electrical connection part of said second.

Claim 11 (Original): The method of a touch panel according to claim 10, wherein said elastic conductive material part is formed in a convex shape.

Claim 12 (Original): The method of a touch panel according to claim 10, wherein said elastic conductive material part is formed in a convex shape and the height from the bottom to the top of said elastic conductive board is set to 200-400 μm .